

Annexure B : Corrigendum

Tender Name: "Procurement of IT infrastructure equipment for various offices of MSEDCL".

Tender No.: HO/IT/Computer Peripherals/2022-23/1

Sr.no.	Reference	Tender Clause	Revised Clause (proposed)
1	SECTION – I 2. QUALIFYING REQUIREMENT:	Documents required: Work Order/LOA /Contract and work completion certificate from client/ purchaser in the last 5 financial years and contact details of the client.	Documents required: Work Order/LOA /Contract and work completion certificate from client/ purchaser in the last 7 financial years and contact details of the client.
2	SECTION – I 2. QUALIFYING REQUIREMENT:	The Bidder should have executed either: 1. One similar work order/Contract costing not less than Rs. 5.72 Crores OR 2. Two similar Work Orders/Contracts costing not less than Rs.3.57 Crores each OR 3. Three similar Work Orders/Contracts costing not less than Rs. 2.86 Crores each of selling computer peripherals in the last 7 financial Years.	The Bidder should have executed either: 1. One similar work order/Contract costing not less than Rs. 5.72 Crores OR 2. Two similar Work Orders/Contracts costing not less than Rs.3.57 Crores each OR 3. Three similar Work Orders/Contracts costing not less than Rs. 2.86 Crores each of supply and installation of computer peripherals/IT infrastructure hardware in the last 7 financial Years.
3	SECTION – II CONDITIONS OF TENDER AND SUPPLY 15. PAYMENT OF BILLS:	100% payment of the contract price of equipment which is successfully supplied, installed and commissioned will be paid within 30 days from the date of receipt of invoice and only after successful, installation and commissioning of more than 80% equipment as per LOA.	100% payment of the contract price of equipment which is successfully supplied, installed and commissioned will be paid within 30 days from the date of receipt of invoice. The payment will be made item wise after complete quantity of that item is supplied.
4	DELIVERY PERIOD:	Bidders shall supply, install & commission the entire material within 90 days from Date of letter of award or Dispatch instructions	Bidders shall supply, install & commission the entire material within 60 days from Date of letter of award.
5	Annexure -D, Serial No.4 Technical Specification Item 1: (i3) Laptop with bag	Min. Intel Core i3 11th or higher generation/ Min. AMD Ryzen 3 5000 Series or higher generation	Min. Intel Core i3 11th or higher generation/ Min. AMD Ryzen 3 3000 Series or higher generation

Sr.no.	Reference	Tender Clause	Revised Clause (proposed)
6	Annexure -D, Serial No.10 Technical Specification Item 1: (i3) Laptop with bag	Storage Capacity- Min. 512 GB SSD	Storage Capacity- Min. 512 GB M.2 NVMe SSD
7	Annexure -D, Serial No.10 Technical Specification Item 2: (i5) Laptop with bag	Storage Capacity- Min. 512 GB SSD	Storage Capacity- Min. 512 GB M.2 NVMe SSD
8	Annexure -D, Serial No.18 Technical Specification Item 1: (i3) Laptop with bag	Pointer Device- touchpad	Pointer Device- Multi-touch gesture-enabled touchpad
9	Annexure -D, Serial No.18 Technical Specification Item 1: (i5) Laptop with bag	Pointer Device- touchpad	Pointer Device- Multi-touch gesture-enabled touchpad
10	Annexure -D, Serial No.20 Technical Specification Item 1: (i3) Laptop with bag	Laptop Keyboard- Standard	Laptop Keyboard- Spill Resistant Keyboard
	Annexure -D, Serial No.20 Technical Specification Item 1: (i5) Laptop with bag	Laptop Keyboard- Standard	Laptop Keyboard- Spill Resistant Keyboard
11	Annexure -D, Serial No.21 Technical Specification Item 1: (i3) Laptop with bag	Battery Capacity: min. 40 Whr	Battery Capacity: min. 38 Whr
12	Annexure -D, Serial No.21 Technical Specification Item 1: (i5) Laptop with bag	Battery Capacity: min. 40 Whr	Battery Capacity: min. 38 Whr
13	Annexure -D, Serial No.27 Technical Specification Item 1: (i3) Laptop with bag	Trusted platform module: TPM 2.0 or higher	Trusted platform module: TPM 2.0 or higher (Hardware based TPM Security)
14	Annexure -D, Serial No.27 Technical Specification Item 1: (i5) Laptop with bag	Trusted platform module: TPM 2.0 or higher	Trusted platform module: TPM 2.0 or higher (Hardware based TPM Security)